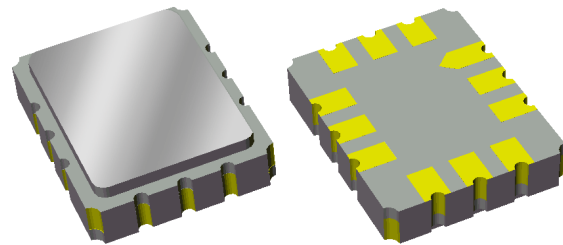


856882

358.4 MHz SAW Filter

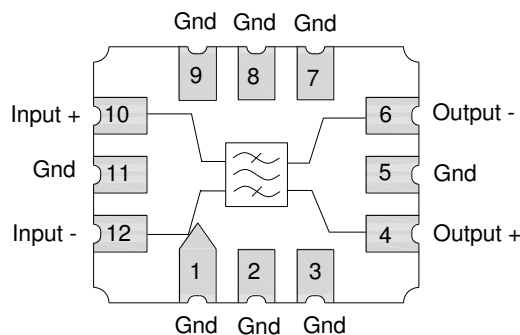
Applications

- General Purpose Wireless
- Wireless Infrastructure
- 3G, 4G, Multistandard



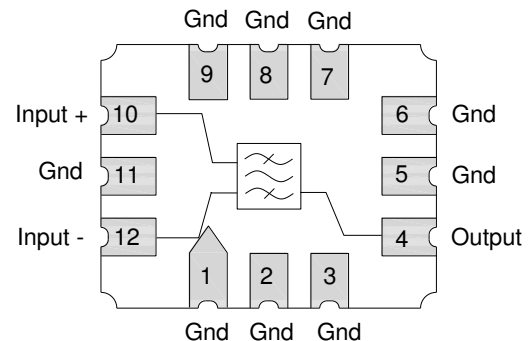
Functional Block Diagram Bal/Bal

Top view



Functional Block Diagram Bal/SE

Top view



Product Features

- Usable bandwidth 39.6 MHz
- Low loss
- High attenuation
- Low EVM
- Balanced-Balanced or Balanced-Single ended operation
- Ceramic Surface Mount Package (SMP)
- Small Size: 7.01 x 5.51 x 1.70 mm
- Excellent power handling
- Hermetic **RoHS** compliant, **Pb-free**

General Description

The 856882 is a high performance IF SAW filter developed for 4G and Multistandard infrastructure applications.

It features low loss with excellent attenuation, and is designed to be used with multiple impedance values and configurations. The filter is developed for excellent in-band characteristics in order to minimize system bit-error rates.

This device is RoHS compliant and Pb-free.

Pin Configuration

Pin #	Bal/Bal	Description
10		Input +
12		Input -
4		Output +
6		Output -
1,2,3,5, 7, 8, 9, 11		Ground

Pin #	Bal/SE	Description
10		Input +
12		Input -
4		Output
1,2,3,5,6, 7, 8, 9, 11		Ground

Ordering Information

Part No.	Description
856882	packaged part
856882-EVB	evaluation board

Standard T/R size = 3000 units/reel.

Please specify the evaluation board impedance:

1. Balanced 200Ω input, Balance 200Ω output.
2. Balanced 200Ω input, Single-ended 50Ω output.
3. Balanced 100Ω input, Balance 100Ω output.

Specifications

Electrical Specifications ^(1, 2)

Specified Temperature Range: ⁽³⁾ -33 to +85 °C

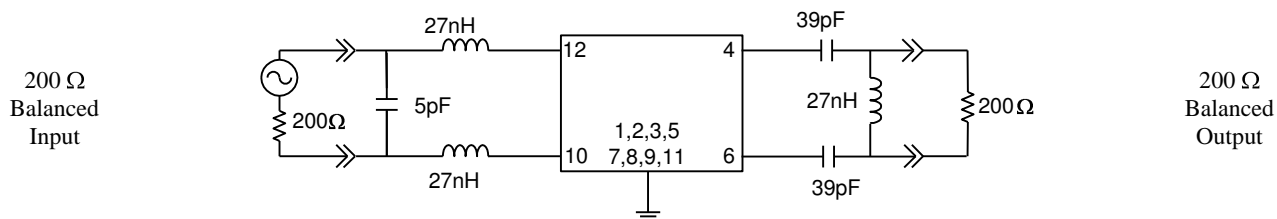
Parameter ⁽⁴⁾	Conditions	Min	Typical ⁽⁵⁾	Max	Units
Center Frequency		-	358.4	-	MHz
Insertion Loss	At 358.4 MHz	-	9.5	11.5	dB
Amplitude Variation ⁽⁶⁾	338.6 – 378.2 MHz	-	0.35	1.0	dB p-p
Absolute Group Delay	At 358.4 MHz	-	0.43	0.5	μs
Group Delay Variation ⁽⁶⁾	338.6 – 378.2 MHz	-	21	50	ns p-p
Time side-lobe response attenuation	(1.0 – 500 μs)	40	45	-	dB
IIP3	Tones 5 MHz separated power > 5dBm per tone	45	50	-	dBm
EVM ⁽⁷⁾		-	1.3	3	%
Absolute Attenuation ⁽⁸⁾					
	10.0 – 253.4 MHz	55	61	-	dB
	253.4 – 270.0 MHz	53	56	-	dB
	270.0 – 294.4 MHz	55	58	-	dB
	294.4 – 312.4 MHz	40	53	-	dB
	312.4 – 326.4 MHz	25	44	-	dB
	326.4 – 338.4 MHz	30	37	-	dB
	338.4 – 404.4 MHz	40	49	-	dB
	404.4 – 422.4 MHz	45	52	-	dB
	422.4 – 463.4 MHz	55	66	-	dB
	463.4 – 660.0 MHz	35	38	-	dB
	660.0 – 780.0 MHz	55	62	-	dB
Input/Output Return Loss	338.6 – 378.2 MHz	10	12	-	dB
Source/Load Impedance ⁽⁹⁾		-	200, 100, 50	-	Ω

Notes:

- All specifications are based on the TriQuint schematics for the different impedances shown on page 3, 4 & 5.
- An external impedance matching network with $\pm 2\%$ tolerance will be necessary to achieve the proposed specifications.
- In production, devices will be tested at room temperature to a guardbanded specification to ensure electrical compliance over temperature.
- Electrical margin has been built into the design to account for the variations due to temperature drift and manufacturing tolerances.
- Typical values are based on average measurements at room temperature.
- These Variations are defined as the difference between the lowest loss and the highest loss within the defined frequency points.
- Measured with an RRC filtered QPSK modulated signal with a BW of 3.84 MHz placed anywhere within 338.6 to 378.2 MHz.
- Relative to insertion loss at center frequency.
- See the impedance options in the ordering information section on page 1.

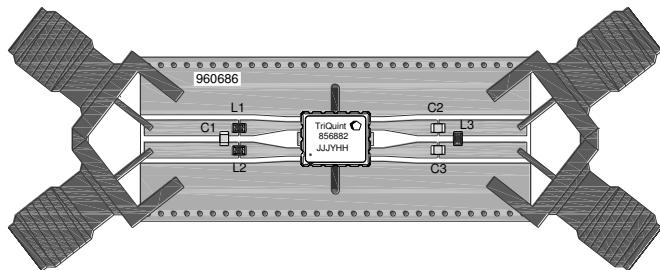
Impedance option #1 – 200Ω Bal Input, 200Ω Bal Output

Schematic



Note: Actual matching values may vary due to PCB layout and parasitic

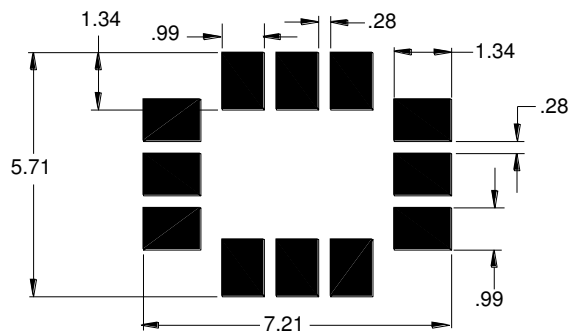
PC Board



Notes:

- Top, middle & bottom layers: 1 oz copper
- Substrates: FR4 dielectric, .031" thick
- Finish plating: Nickel: 3-8μm thick, Gold: .03-.2μm thick
- Hole plating: Copper min .0008μm thick

Mounting Configuration



Notes:

1. All dimensions are in millimeters.
2. This footprint represents a recommendation only.

Bill of Material

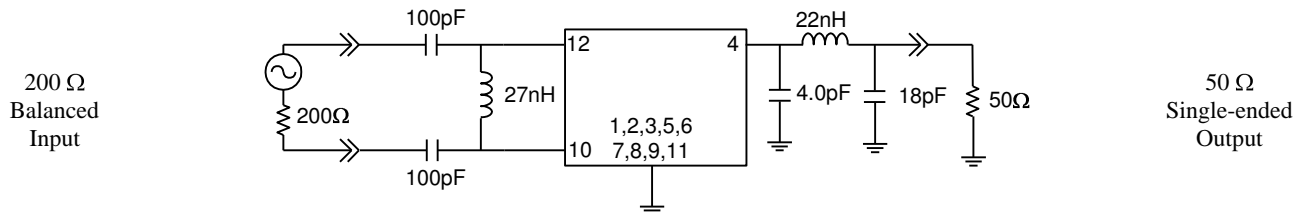
Reference Desg.	Value	Description	Manufacturer	Part Number
C1	5.0 pF	Chip Ceramic, 0603, 5%	Panasonic	ECU-V1H0050CCV
C2	39 pF	Chip Ceramic, 0603, 5%	Panasonic	ECU-V1H390KCV
C3	39 pF	Chip Ceramic, 0603, 5%	Panasonic	ECU-V1H390KCV
L1	27nH	Coil Wire-wound, 0603, 5%	Coilcraft	0603CS-27NXJBC
L2	27nH	Coil Wire-wound, 0603, 5%	Coilcraft	0603CS-27NXJBC
L3	27nH	Coil Wire-wound, 0603, 5%	Coilcraft	0603CS-27NXJBC
SMA	N/A	SMA connector	Johnson Components	142-0701-801
PCB	N/A	3-layer	multiple	960686

856882

358.4 MHz SAW Filter

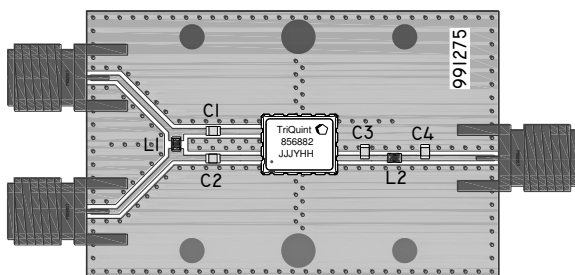
Impedance option #2 – 200Ω Bal Input, 50Ω SE Output

Schematic



Note: Actual matching values may vary due to PCB layout and parasitic

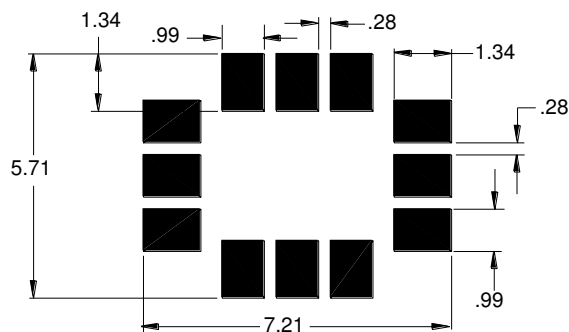
PC Board



Notes:

- Top, middle & bottom layers: 1 oz copper
- Substrates: FR4 dielectric, .031" thick
- Finish plating: Nickel: 3-8μm thick, Gold: .03-.2μm thick
- Hole plating: Copper min .0008μm thick

Mounting Configuration



Notes:

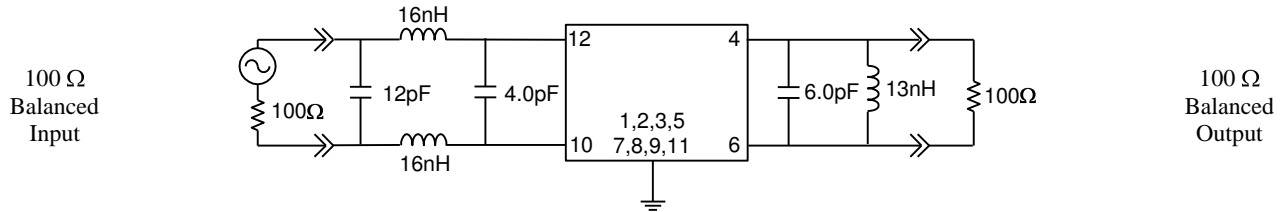
- 3. All dimensions are in millimeters.
- 4. This footprint represents a recommendation only.

Bill of Material

Reference Desg.	Value	Description	Manufacturer	Part Number
C1	100 pF	Chip Ceramic, 0603, 5%	Panasonic	ECU-V1H101KCV
C2	100 pF	Chip Ceramic, 0603, 5%	Panasonic	ECU-V1H101KCV
C3	4.0 pF	Chip Ceramic, 0603, 5%	Panasonic	ECU-V1H040CCV
C4	18 pF	Chip Ceramic, 0603, 5%	Panasonic	ECU-V1H0180KCV
L1	27 nH	Coil Wire-wound, 0603, 5%	MuRata	LQW18AN27NJ00
L2	22 nH	Coil Wire-wound, 0603, 5%	MuRata	LQW18AN22NJ00
SMA	N/A	SMA connector	Johnson Components	142-0701-801
PCB	N/A	3-layer	multiple	991275

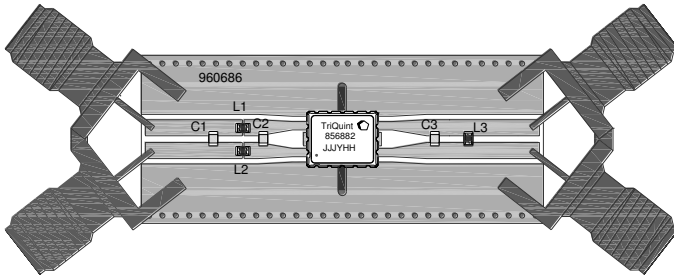
Impedance option #3 100Ω Bal Input, 100Ω Bal Output

Schematic



Note: Actual matching values may vary due to PCB layout and parasitic

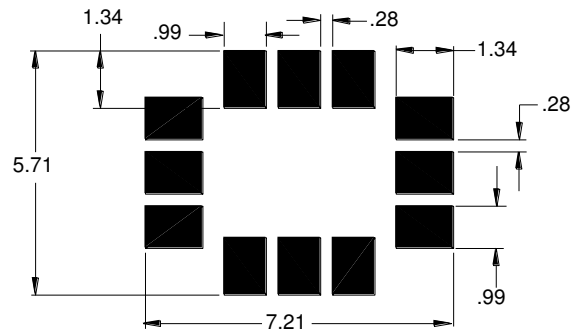
PC Board



Notes:

- Top, middle & bottom layers: 1 oz copper
- Substrates: FR4 dielectric, .031" thick
- Finish plating: Nickel: 3-8μm thick, Gold: .03-.2μm thick
- Hole plating: Copper min .0008μm thick

Mounting Configuration



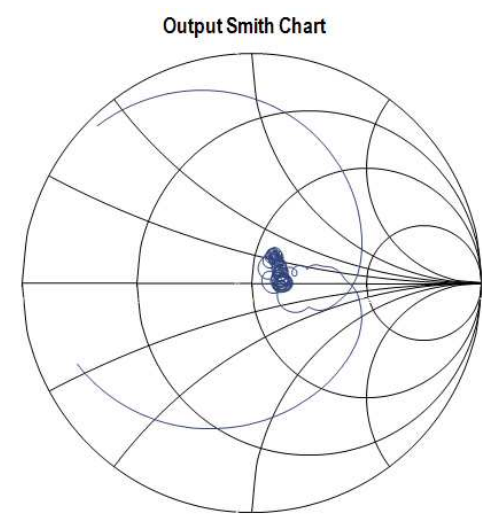
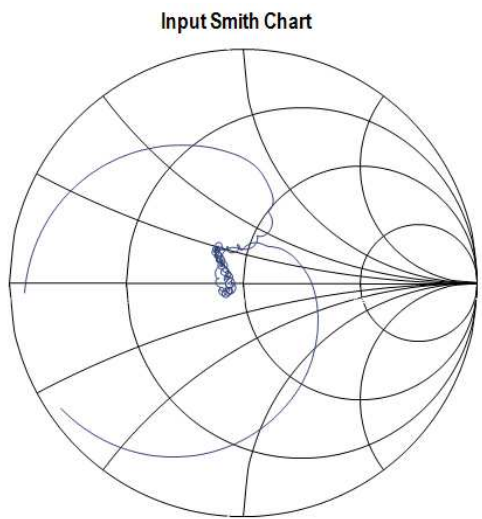
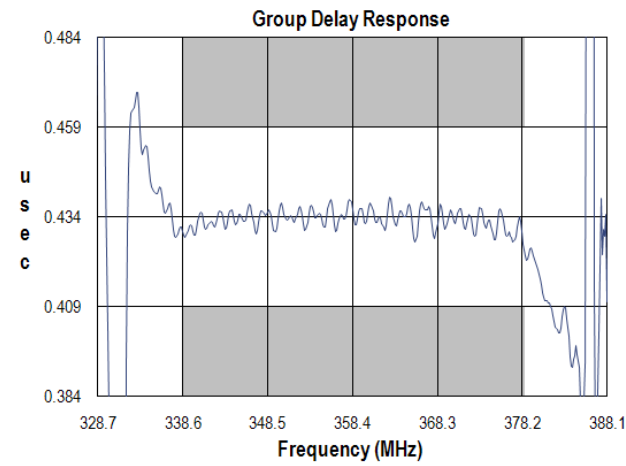
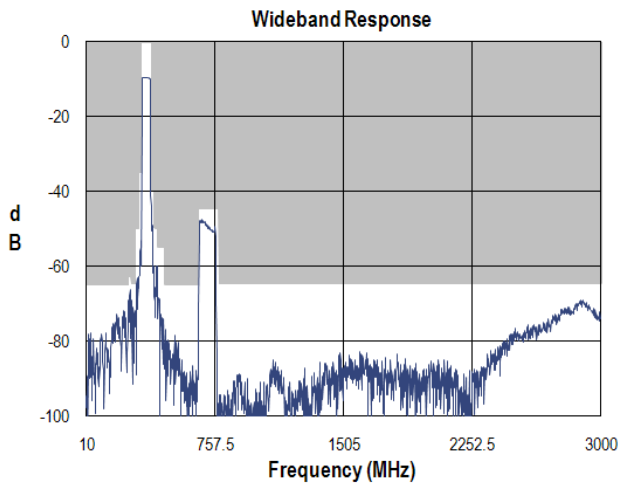
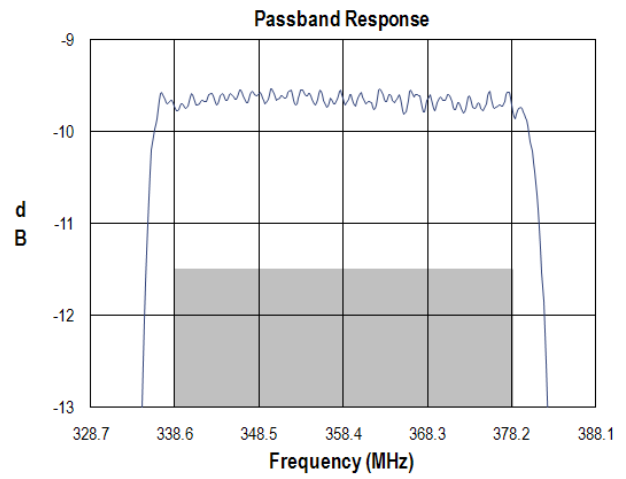
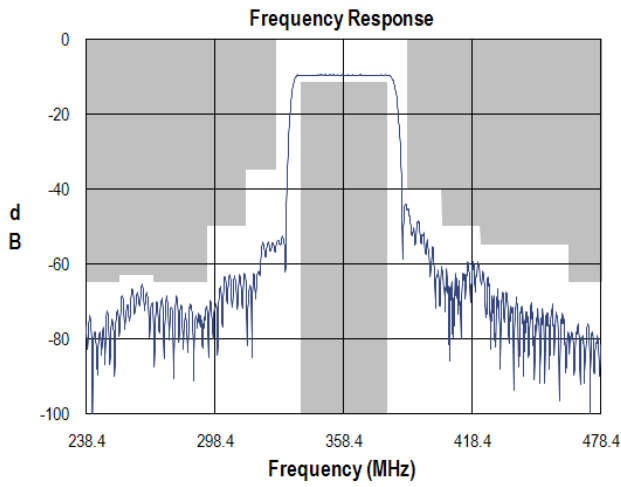
Notes:

- 5. All dimensions are in millimeters.
- 6. This footprint represents a recommendation only.

Bill of Material

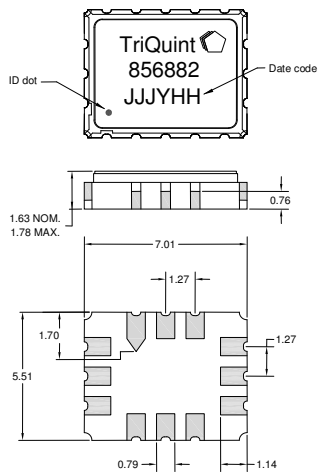
Reference Desg.	Value	Description	Manufacturer	Part Number
C1	12 pF	Chip Ceramic, 0603, 5%	Panasonic	ECU-V1H120JCV
C2	4.0 pF	Chip Ceramic, 0603, 5%	Panasonic	ECU-V1H040CCV
C3	6.0 pF	Chip Ceramic, 0603, 5%	Panasonic	ECU-V1H060CCV
L1	16 nH	Coil Wire-wound, 0603, 5%	MuRata	LQW18AN16NJ00
L2	16 nH	Coil Wire-wound, 0603, 5%	MuRata	LQW18AN16NJ00
L3	13 nH	Coil Wire-wound, 0603, 5%	MuRata	LQW18AN13NJ00
SMA	N/A	SMA connector	Johnson Components	142-0701-801
PCB	N/A	3-layer	multiple	960686

Typical Performance (at room temperature)



Mechanical Information

Package Information, Dimensions and Marking



Package Style: SMP-28B
 Dimensions: 7.01 x 5.51 x 1.63 mm

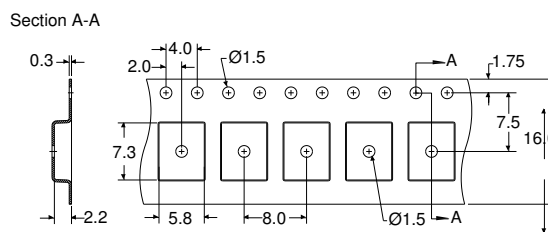
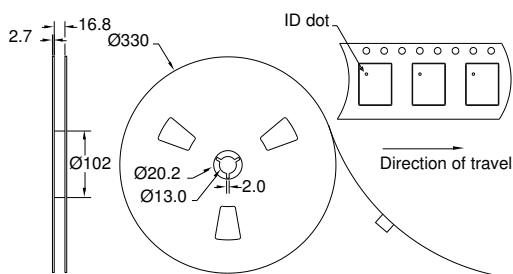
Body: Al₂O₃ ceramic
 Lid: Kovar, Ni plated
 Terminations: Au plating 0.5 - 1.0µm, over a 2-6µm Ni plating

All dimensions shown are nominal in millimeters
 All tolerances are ±0.15mm except overall length and width ±0.10mm

The date code consists of: day of the current year (Julian, 3 digits), Y = last digit of the year (1 digit), and HH = hour (2 digits)

Tape and Reel Information

Standard T/R size = 3000 units/reel. All dimensions are in millimeters



Absolute Maximum Ratings

Parameter	Condition	Value	Unit
Operating Temperature range		-33 to +85	°C
Storage Temperature range		-40 to +85	°C
Input Power	24 Hrs at 50°C, in band	+19	dBm
	24 Hrs at 50°C, out of band	+25	dBm
DC Voltage	Between input/output and ground	5	V
DC Voltage	Between terminals 10/12 or 4/6	5	V
Moisture Sensitivity level		MSL3 or better	-

Operation of this device outside the parameter ranges given above may cause permanent damage.

Product Compliance Information

ESD Information



Caution! ESD-Sensitive Device

ESD Rating: 1B

Value: Passes ≥ 550 V min.
 Test: Human Body Model (HBM)
 Standard: JEDEC Standard JESD22-A114

ESD Rating: B

Value: Passes ≥ 350 V min.
 Test: Machine Model (MM)
 Standard: JEDEC Standard JESD22-A115

MSL Rating

Devices are Hermetic, therefore MSL is not applicable

Solderability

Compatible with the latest version of J-STD-020, lead free solder, 260°C

Refer to **Soldering Profile** for recommended guidelines.

This part is compliant with EU 2002/95/EC RoHS directive (Restrictions on the Use of Certain Hazardous Substances in Electrical and Electronic Equipment).

This product also has the following attributes:

- Halogen Free (Chlorine, Bromine)
- Antimony Free
- TBBP-A (C₁₅H₁₂Br₄O₂) Free
- PFOS Free
- SVHC Free

Contact Information

For the latest specifications, additional product information, worldwide sales and distribution locations, and information about TriQuint:

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 Email: info-sales@tqs.com Fax: +1.407.886.7061

For technical questions and application information:

Email: flapplication.engineering@tqs.com

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